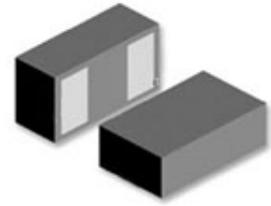
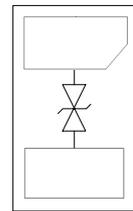


Features

- Low capacitance: 0.45pF typical
- Ultra low leakage: nA level
- Operating voltage: 3.3V
- Low clamping voltage
- 2-pin leadless package
- Complies with following standards:
 - IEC 61000-4-2 (ESD) immunity test
Air discharge: ± 30 kV
Contact discharge: ± 30 kV
 - IEC 61000-4-5 (Lightning) 10A (8/20 μ s)
- RoHS compliant



DFN0603



Schematic Diagram

Applications

- Cellular handsets and accessories
- Display ports
- MDDI / MHL
- USB 2.0 / USB 3.0
- Digital visual interface (DVI)
- PCI express and serial SATA ports

Absolute Maximum Ratings (T_A=25°C unless otherwise specified)

Parameter	Symbol	Value	Unit
Peak Pulse Power (8/20 μ s)	P _{pk}	60	W
Peak Pulse Current (8/20 μ s)	I _{pp}	10	A
ESD Per IEC 61000-4-2 (Air)	V _{ESD}	± 30	kV
ESD Per IEC 61000-4-2 (Contact)		± 30	
Operating Temperature Range	T _J	-40 to +125	°C
Storage Temperature Range	T _{stg}	-55 to +150	°C

Electrical Characteristics (T_A=25°C unless otherwise specified)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Reverse Working Voltage	V _{RWM}	-	-	-	3.3	V
Punch-Through Voltage	V _{PT}	I _{PT} =2 μ A	3.5	-	-	V
Breakdown Voltage	V _{BR}	I _T =1mA	4	-	-	V
Snap-Back Voltage	V _{SB}	I _{SB} =50mA	2	-	-	V
Reverse Leakage Current	I _R	V _{RWM} =3.3V	-	-	0.5	μ A
Clamping Voltage	V _C	I _{pp} =10A (8 x 20 μ s pulse)	-	4	6	V
Junction Capacitance	C _J	V _R =0V, F=1MHz	-	0.45	0.55	pF

Typical Performance Characteristics ($T_A=25^\circ\text{C}$ unless otherwise Specified)

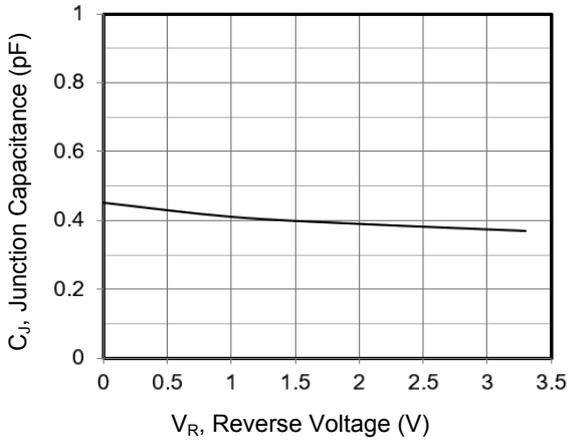


Figure 1. Junction Capacitance vs. Reverse Voltage

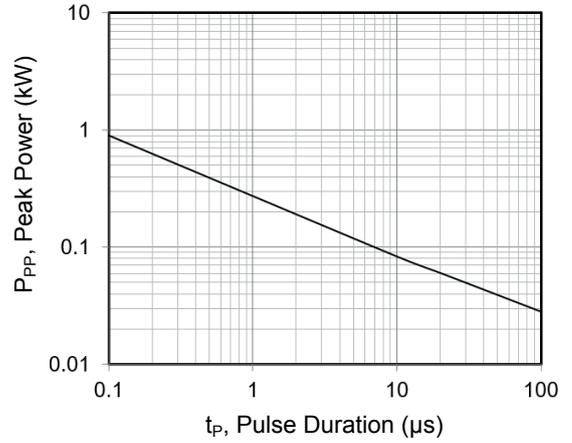


Figure 2. Peak Pulse Power vs. Pulse Time

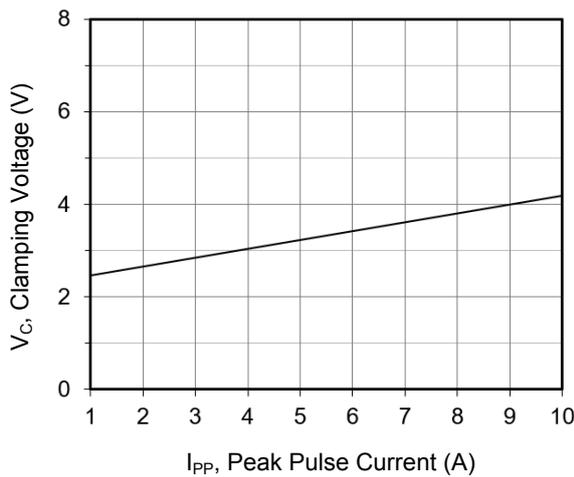


Figure 3. Clamping Voltage vs. Peak Pulse Current
 $(t_p=8/20\mu\text{s})$

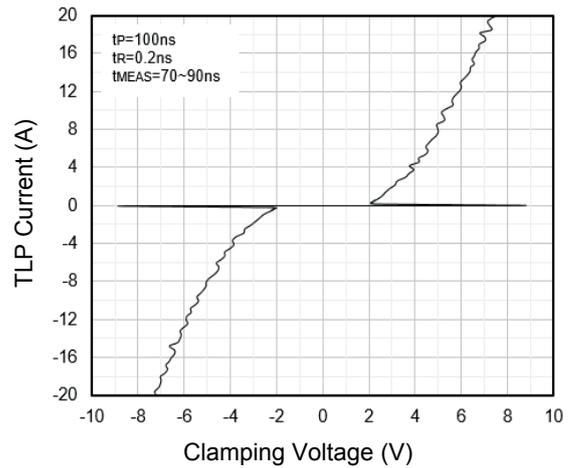


Figure 4. TLP Curve

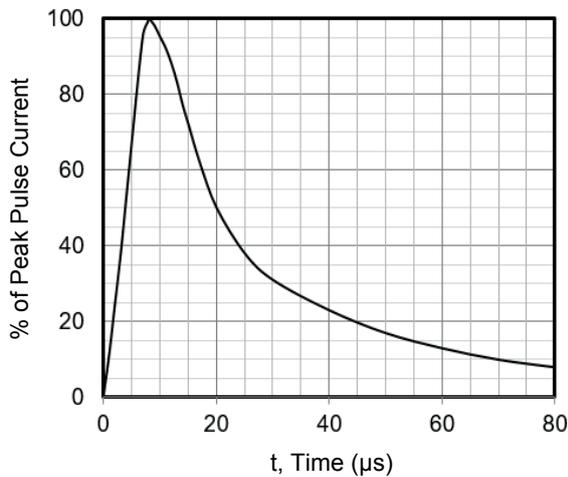


Figure 5. 8 X 20 μs Pulse Waveform

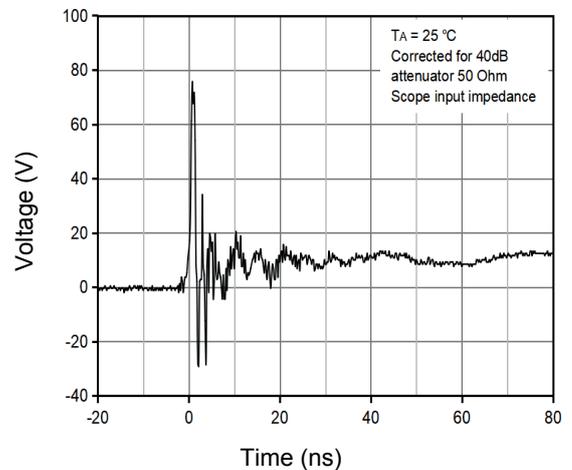
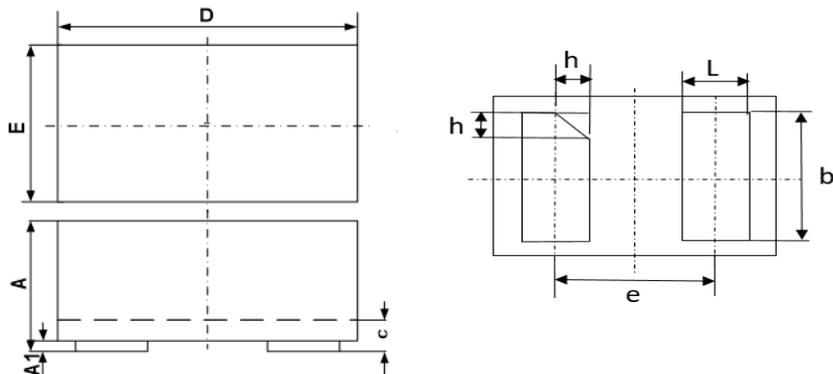


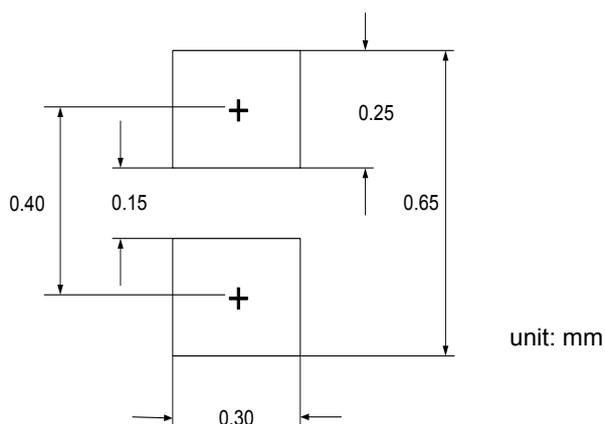
Figure 6. ESD Clamping Voltage
8kV Contact per IEC61000-4-2

Package Outline Dimensions (DFN0603)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.280	0.320	0.011	0.013
A1	0.000	0.050	0.000	0.002
b	0.200	0.300	0.008	0.012
c	0.050	0.150	0.002	0.006
D	0.550	0.650	0.022	0.026
e	0.355 BSC		0.014 BSC	
E	0.250	0.350	0.010	0.014
L	0.130	0.240	0.005	0.009
h	0.050 BSC		0.002 BSC	

Recommended Pad Layout



Order Information

Device	Package	Marking	Carrier	Quantity
GSEN3B0045	DFN0603	4S	Tape & Reel	10,000 pcs / Reel

For more information, please contact us at: inquiry@goodarksemi.com